

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	236	fuse same semiconductor same locat\$4 same memory	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 14:57
S2	82	fuse same semiconductor same locat\$4 same memory same defect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 12:28
S3	960	fuse with defect\$4 same semiconductor same memory	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 12:29
S4	53	fuse with defect\$4 same semiconductor same memory same locat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 12:30
S5	6	fuse with defect\$4 same semiconductor same memory same locat\$4 and (fuse.ti.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 12:37
S6	11	("5835431" "5933376" "6008523" "6119251" "6266792" "6408401" "6477095" "6479310" "6578157" "20020085439" "20020133770"). PN.	US-PGPUB; USPAT	OR	ON	2005/01/12 12:37
S7	11	("5835431" "5933376" "6008523" "6119251" "6266792" "6408401" "6477095" "6479310" "6578157" "20020085439" "20020133770"). PN. and fuse and memory	US-PGPUB; USPAT	OR	ON	2005/01/12 12:37
S8	7	("5835431" "5933376" "6008523" "6119251" "6266792" "6408401" "6477095" "6479310" "6578157" "20020085439" "20020133770"). PN. and fuse with defect\$4 and memory	US-PGPUB; USPAT	OR	ON	2005/01/12 12:40
S9	566	test\$3 with fuse with defect\$5 and memory and semiconductor	US-PGPUB; USPAT	OR	ON	2005/01/12 12:40
S10	57	test\$3 with fuse with defect\$5 same locat\$4 and memory and semiconductor	US-PGPUB; USPAT	OR	ON	2005/01/12 13:41
S11	0	test\$3 near fuse near defect\$5 same locat\$4 and memory and semiconductor	US-PGPUB; USPAT	OR	ON	2005/01/12 12:42

S12	0	test\$3 near fuse near defect\$5 and memory and semiconductor	US-PGPUB; USPAT	OR	ON	2005/01/12 13:41
S13	73	test\$3 with fuse with defect\$5 same plurality and memory and semiconductor	US-PGPUB; USPAT	OR	ON	2005/01/12 13:59
S14	0	(test\$3 with fuse with defect\$5).ti.	US-PGPUB; USPAT	OR	ON	2005/01/12 13:50
S15	11	(test\$3 and fuse and defect\$5).ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 13:51
S16	98	test\$3 with fuse same defect\$5 same plurality and memory and semiconductor	US-PGPUB; USPAT	OR	ON	2005/01/12 13:57
S17	1	test\$3 near fuse same defect\$5 same plurality and memory and semiconductor	US-PGPUB; USPAT	OR	ON	2005/01/12 13:57
S18	62	test\$3 with defect\$4 near fuse and semiconductor and memory	US-PGPUB; USPAT	OR	ON	2005/01/12 14:11
S19	66	test\$3 with defect\$4 near fuse and memory	US-PGPUB; USPAT	OR	ON	2005/01/12 14:06
S20	2	test\$3 with defect\$4 near fuse and semiconductor and memory	USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 14:16
S21	54	test\$3 near fuse with defect\$4 and semiconductor and memory	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 14:18
S22	82	(defect defective) near fuse same test\$3 and semiconductor and memory	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 15:09
S23	64	(defect defective) near fuse with test\$3 and semiconductor and memory	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 15:09
S24	2	(defect defective) near fuse near test\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 15:12
S25	30	(defect defective) near fuse same test\$3 same (semiconductor die wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 15:14

S26	30	(defect defective) near fuse same test\$3 same (semiconductor die wafer) and fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 15:19
S27	17	(faulty broken) near fuse same test\$3 same (semiconductor die wafer) and fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 17:21
S28	57	fuse near evaluat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 17:21
S29	17	fuse near evaluat\$4 and semiconductor and memory	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/12 17:21
S30	0	test\$3 same common near location same semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 11:26
S31	522	test\$3 same plurality same location same semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 11:27
S32	233	test\$3 same plurality same location same semiconductor with device	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 11:27
S33	20	test\$3 same plurality same location same semiconductor with device same defect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 11:28
S34	12	test\$3 same plurality with semiconductor with device same location same defect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 16:31
S35	0	ouput near report same (faulty deenerate defective) same fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 12:53

S36	0	ouput near report same (faulty deenerate defective)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 12:53
S37	0	ouput near report same (faulty degenerate defective)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 12:53
S38	0	test\$3 same plurality with semiconductor with device same location same defect\$4 and report	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/13 16:31
S39	3	report with print with defective	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/01/18 12:18
S40	0	fuse same semiconductor same locat\$4 same memory same (defect\$4 fail\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:54
S41	106	fuse same semiconductor same locat\$4 same memory same (defect\$4 fail\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:54
S42	62	semiconductor same fuse with locat\$4 same memory same (defect\$4 fail\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:55
S43	2457	test\$4 with fuses!3 same semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:55
S44	371	test\$4 with fuses! same semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:56
S45	15	test\$4 with fuses! same semiconductor and memory same location same defect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:58

S46	3	test\$4 near fuses! same semiconductor and memory same location same defect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:59
S47	14	test\$4 near fuses! same semiconductor and memory same fuse same defect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:59
S48	12	test\$4 near fuses! same semiconductor and memory same fuse same defect\$4 and fuse.ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/15 13:59
S49	5	defect\$4 with fuse same test\$4 and common near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 15:17
S50	2	defect\$4 near fuse same test\$4 and common near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 15:16
S51	0	defect\$4 near fuse same test\$4 and identical near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 15:16
S52	60	defect\$4 with fuse same test\$4 and sam\$2 near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 15:22
S53	54	test\$4 with fuse and defect\$4 with fuse and (sam\$2 common) near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 15:28
S54	6	test\$4 near fuse and defect\$4 near fuse and (sam\$2 common) near (address location)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 16:02
S55	16	output with location with defective with fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 16:45

S56	0	output\$4 near location with defective near fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 16:03
S57	0	output\$4 near location with defect\$4 near fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/20 16:03
S58	16	output\$4 with location with defect\$4 with fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 11:29
S59	2	output\$4 with location with defect\$4 with fuse and common near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 12:03
S60	1	test\$4 near fuses same common near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 12:04
S61	1	test\$4 near fuses same sam\$2 near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 12:05
S62	2	test\$4 with fuses same sam\$2 near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 12:05
S63	4	test\$4 with fuses same (common sam\$2) near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 12:06
S64	7	test\$4 with fuses same (common sam\$2) near address	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 12:06
S65	18	test\$4 with (common sam\$2) with (location address) and test\$4 near fuse and defect	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:26

S66	12	(common sam\$2) with (location address) and test\$4 near fuse and defect\$4 near fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:40
S67	4	(common sam\$2) with (location address) and test\$4 near fuse and defect\$4 near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:59
S68	2	defective adj fuse and test\$4 near fuses! and (common sam\$2) near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:42
S69	2	defect\$4 adj fuse and test\$4 near fuses! and (common sam\$2) near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:42
S70	1	blown adj fuse and test\$4 near fuses! and (common sam\$2) near location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:43
S71	4	report with defect\$4 with fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:44
S72	103	test\$4 near fuse same semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:45
S73	82	test\$4 near fuse same semiconductor and memory	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:45
S74	6	test\$4 near fuse same semiconductor and memory and defective near fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:47
S75	0	test\$4 near fuse same semiconductor and memory and defective near fuse with frequent	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:47

S76	0	test\$4 near fuse and semiconductor and memory and defective near fuse with frequent\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:47
S77	2	test\$4 near fuse and semiconductor and memory and defective near fuse with locat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:48
S78	161	fuse with location with defect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:48
S79	68	fuse with location with defect\$4 and memory and test\$4 with fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:48
S80	14	fuse with location with defect\$4 and memory and test\$4 with fuse and fuse.ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:49
S81	5	fuse with location with defect\$4 and memory and test\$4 near fuse and fuse.ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:50
S82	0	fuse with location with broken and memory and test\$4 near fuse and fuse.ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:51
S83	16	output\$4 with location with (broken defective) with fuses	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:56
S84	12	test\$4 with plurality with fuses! with devices!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:57
S85	2408636	test\$4 with plurality with fuses! with devices! and test\$3 near\$3 fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:58

S86	3	test\$4 with plurality with fuses! with devices! and test\$3 near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 13:58
S87	0	corresponding with (location address) and test\$4 near fuse and defect\$4 near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:01
S88	2	correspond\$4 with (location address) and test\$4 near fuse and defect\$4 near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:04
S89	2451	test\$4 with fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:04
S90	315	test\$4 near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:05
S91	4	test\$4 near plurality near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:05
S92	12	test\$4 near fuses! and (defective broken) near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:07
S93	4	test\$4 near fuses! and (defective broken) near fuses! and (semiconductor wafer die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:06
S94	38	test\$4 near fuses! and (blown) near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:07
S95	20	test\$4 near fuses! and (blown) near fuses! and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:12

S96	0	rate near failure near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:13
S97	21	rate with fail\$4 with fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:13
S98	2	rate with fail\$4 with fuses! and test\$4 near fuses!	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:16
S99	180	324/550.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:17
S10 0	32	324/550.ccls. and location	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:17
S10 1	13	324/550.ccls. and location and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:18
S10 2	7	324/550.ccls. and location and semiconductor and fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/21 14:19